

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT7094201

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DONGFANG ZHAO	08/25/2021
YONGKUN GAO	08/25/2021
MIN LIU	08/25/2021
RECEIVING PARTY DATA	
Name:	QINGDAO HISENSE HITACHI AIR-CONDITIONING SYSTEMS CO., LTD.
Street Address:	NO.218 QIANWANGANG ROAD
Internal Address:	ECONOMIC AND TECHNICAL DEVELOPMENT ZONE
City:	QINGDAO, SHANDONG
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17562376
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NAME OF SUBMITTER:	ANGELA Y. ELLIS
SIGNATURE:	/Angela Y. Ellis/
DATE SIGNED:	12/27/2021
Total Attachments: 2	
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**Title of
Invention**

As the below named and undersigned inventor, I hereby declare that:

The attached application, or

United States application or PCT international application number
filed on _____.

Note to inventor: 37 C.F.R. § 1.63(c) states: *A person may not execute an oath or declaration for an application unless that person has reviewed and understands the contents of the application, including the claims, and is aware of the duty to disclose to the Office all information known to the person to be material to patentability defined in § 1.56.*

I hereby assign to the ASSIGNEE, and its lawful successors and assigns, the right to file patent applications in foreign countries on said invention in its own name and the right to claim priority to the above-identified United States patent application under the terms of the International Convention and any

other relevant treaties;

I hereby authorize and request the United States Patent and Trademark Office and officials in patent offices in foreign countries to issue any and all of said Letters Patent to the ASSIGNEE as the assignee of my entire right, title, and interest in and to the same, for the sole use and benefit of the ASSIGNEE, and its lawful successors and assigns, to the full end of the term for which said Letters Patent may be granted;

I hereby grant the attorney of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office or other authority for recordation of this document;

I hereby covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment; and

Further, I hereby further covenant and agree that I will, without further consideration, communicate with the ASSIGNEE, and its lawful successors and assigns, any facts known to me respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said ASSIGNEE, and its lawful successors or assigns, execute all divisional, continuation, continuation-in-part, and reissue applications, make all rightful oaths and generally do everything possible to aid the ASSIGNEE, and its lawful successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the ASSIGNEE, and its lawful successors and assigns.

IN TESTIMONY WHEREOF, I have hereunto set my hands.

NAME OF INVENTOR (Full Legal Name): **Dongfang ZHAO**

Signature: Dongfang ZHAO Date: 8/25/2021

NAME OF INVENTOR (Full Legal Name): **Yongkun GAO**

Signature: Yongkun GAO Date: 8/25/2021

NAME OF INVENTOR (Full Legal Name): **Min LIU**

Signature: Min LIU Date: 8/25/2021

Morgan, Lewis & Bockius LLP

PATENT

RECORDED: 12/27/2021

REEL: 058485 FRAME: 0504